

## CDR02BX123AKSP-T&R

Aliases (C1805P123K5XPH7189)

SMD Mil PRF55681, Ceramic, 0.012 uF, 10%, 50 VDC, BX, P (0.1%/1000 Hrs), 1805



Click here for the 3D model.

Dimensions	
Chip Size	1805
L	4.57mm +1.02/-0.38mm (0.18 in +0.04/-0.015 in)
W	1.27mm +0.76/-0.38mm (0.05 in +0.03/-0.015 in)
Т	0.98mm +0.8/-0.42mm (0.039 in +0.031/-0.017 in)
В	0.51mm +0.63/-0.25mm (0.02 in +0.025/-0.01 in)

Packaging Specifications	
Packaging	T&R, 178mm, Plastic Tape
Packaging Quantity	2500

General Information	
Series	SMD Mil PRF55681
Style	SMD Chip
RoHS	No
Prop 65	▲ WARNING: Cancer and reproductive harm - http://www.p65warnings.ca.gov.
SCIP Number	de44f0ec-7e7c-4120-b42e-f63f667919b6
Termination	Lead (SnPb)
Failure Rate	P (0.1%/1000 Hrs)
Testing and Reliability	MIL-PRF-55681
Qualifications	MIL-PRF-55681
AEC-Q200	No
Miscellaneous	Termination Description: SolderCoat 60-40.
Shelf Life	78 Weeks
MSL	1

Specifications	
Capacitance	0.012 uF
Capacitance Tolerance	10%
Voltage DC	50 VDC
Temperature Range	-55/+125°C
Temperature Coefficient	BX

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